

C1812C331MHRACTU

Aliases (C1812C331MHRAC7800)

SMD Comm X7R HV, Ceramic, 330 pF, 20%, 3,000 VDC, X7R, SMD, MLCC, High Voltage, Temperature Stable, 1812, 2.3 mm



General Information	
Series	SMD Comm X7R HV
Style	SMD Chip
Description	SMD, MLCC, High Voltage, Temperature Stable
Features	High Voltage
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Typical Component Weight	95 mg
Shelf Life	78 Weeks
MSL	1

Dimensions	
Chip Size	1812
L	4.5mm +/-0.3mm
W	3.2mm +/-0.3mm
Т	1mm +/-0.10mm
S	2.3mm MIN
В	0.6mm +/-0.35mm

Packaging Quantity

W	3.2mm +/-0.3mm	Tolera
Т	1mm +/-0.10mm	Voltag
S	2.3mm MIN	Dielec
В	0.6mm +/-0.35mm	Tempe
		Temp.
Packaging Specifications		Capac
Packaging	T&R, 180mm, Plastic Tape	Refere

1000

Specifications	
Capacitance	330 pF
Measurement Condition	1 kHz 1.0Vrms
Tolerance	20%
Voltage DC	3000 VDC
Dielectric Withstanding Voltage	3,600 VDC
Temperature Range	-55/+125°C
Temp. Coefficient	X7R
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	15%, 1kHz 1.0Vrms
Dissipation Factor	2.5% 1 kHz 1.0 Vrms
Aging Rate	3% Loss/Decade Hour: Referee Time is 1000 Hours
Insulation Resistance	100 GOhms

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